



MTC811

Epoxy Component Prepreg

Introduction

MTC811 is a toughened, honeycomb bondable epoxy resin system designed to produce a durable cost effective component with an excellent surface finish. It can be supplied on a variety of fabrics and in UD format to meet your cost and manufacturing requirements.

Typical applications: General Purpose – Visual

Key Features & Benefits

- Cure temperature from **195°F** to **250°F**
- Service temperature up to **240°F**
- Low CTE and shrinkage
- Work life at 70°F: **60 days**
- Storage life at 0°F: **12 months**
- Very low VOC content – no added solvents during manufacture
- Excellent surface finish
- **Honeycomb** bondable

Storage & Out Life

This material should be kept frozen at 0°F. It must be kept sealed in a polythene bag which must not be opened until fully thawed to room temperature. If the material is not fully used, then the material must be resealed in the polythene bag to prevent moisture absorption.



Cure Cycles & performances

CURE CYCLE OPTIONS:

Temperature	Duration	Tg
195°F (minimum)	14 hours	195°F
210°F	6 hours	210°F
250°F (maximum)	1 hour	250°F

- Curing Schedule is meant to be a guide only and is subject to local conditions.
- To avoid exotherm particular care must be taken with thick laminates.
Ramp rates must not exceed **5°F** per minute during **initial cure**.
Ramp rates must not exceed **1°F** per minute during **post cure** (free standing).

Cured Material Properties

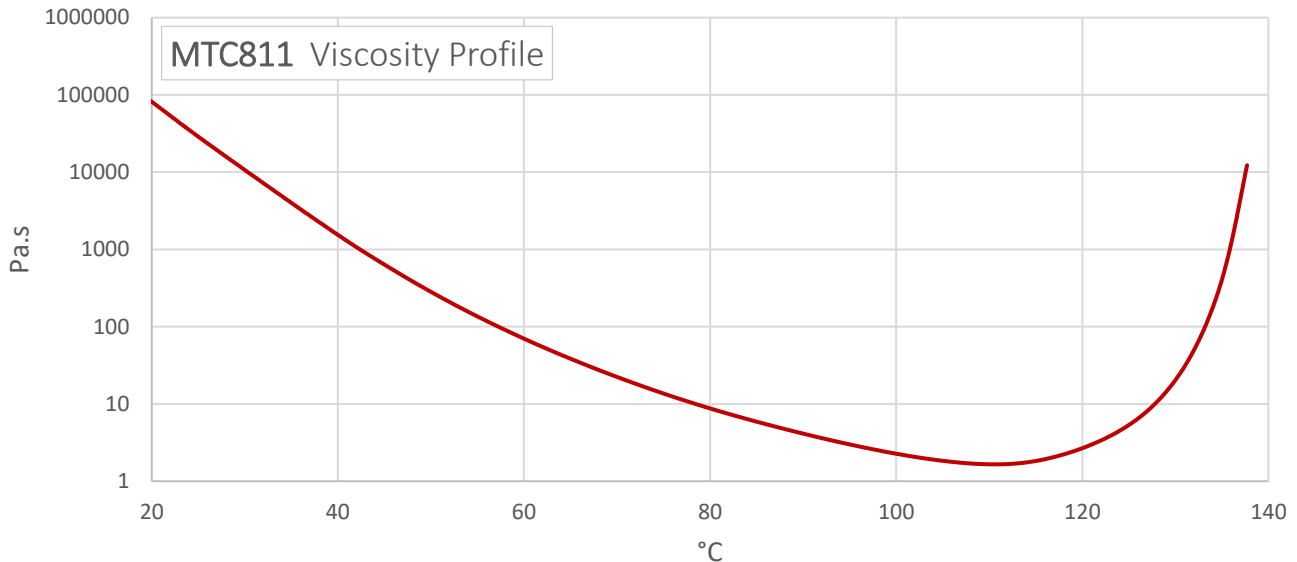
Tests performed on **MTC811-C200T-T300-2X2T-3K-42%RW** laminates

Test	Results	Standard
Compression	Compressive strength	614 MPa
	Compressive modulus	52.3 GPa
Tension	Tensile strength	624 MPa
	Tensile modulus	57.3 GPa
Flexure	Flexural strength	921 MPa
	Flexural modulus	53.6 GPa
Interlaminar Shear Strength	Interlaminar shear strength	68.8 MPa
In Plane Shear	IPS strength	116 MPa
	IPS modulus	3.40 GPa
DMA	Tg – Storage Modulus Onset	250 °F
	Tg – Tan δ Peak	262 °F

Mechanical testing carried out at 70°F±4°F, 50±5% RH. Mechanical testing was completed in house. Initial cure 2 hrs @ 230°F @ 5°F/min 90psi. Complete tests reports can be supplied independently upon request. All figures are actual test results and haven't been normalised.



Viscosity Profile



Health and Safety

This material contains epoxy resin which can cause allergic reactions with skin contact and must avoid repeated and prolonged skin contact.

Please refer to the product Safety Data Sheet before using this material. The following precautions must be taken when using epoxy resin prepregs:

- Overalls must be worn.
- Impervious gloves must be worn.
- Curing schedule is meant to be as a guide only and is subject to local conditions.
- To avoid exotherm, particular care must be taken with thick laminates.
- Ramp rates must not exceed 5°F/min during initial cure and 1°F/min during post cure.

Disclaimer: Technical advice, instruction, data or recommendation, whether verbal or in writing, is given in good faith. The SHD company providing any such advice gives no warranty or guarantee, whether express or implied, in relation to such advice.

Customers must carry out their own tests and assessments as necessary in order to determine the quality and suitability of the product for their particular application and circumstances. Such testing should be performed under conditions identical to those to which the final component/product may be subjected. Values listed in any SHD document are for typical properties of the product or substance in question and are not intended to be used in establishing either statistical specifications nor engineering basis values. They do not constitute either minimum or maximum values for the product or substance in question.